

CM1407

4 and 8-Channel EMI Filter Arrays with ESD Protection

Product Description

ON Semiconductor CM1407 is an EMI filter array with ESD protection, which integrates either four or eight pi filters (C-R-C). The CM1407 has component values of 7.5 pF – 200 Ω – 7.5 pF ($f_C = 210$ MHz). The parts include ESD protection diodes on every pin, providing a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes connected to the filter ports safely dissipate ESD strikes of ±15 kV contact discharge, twice the specification requirement of the IEC 61000-4-2, Level 4 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±30 kV.

This device is particularly well-suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package and easy-to-use pin assignments. In particular, the CM1407 is ideal for EMI filtering and protecting data lines from ESD in wireless handsets.

The CM1407 is available in space-saving, low-profile, 8 and 16-lead WDFN packages. It is fabricated with ON Semiconductor's *Centurion*™ process and available with optional lead-free finishing.

Features

- Four and Eight Channels of EMI Filtering with ESD Protection
- Greater than 25 dB of Attenuation from 800 Mhz to 3 GHz
- ±15 kV ESD Protection (IEC 61000-4-2, Contact Discharge)
- ±30 kV ESD Protection (MIL-STD-883, Method 3015, HBM)
- Fabricated with *Centurion*™ Advanced Low Capacitance Zener Process Technology
- Space Saving, Low Profile 8 and 16-lead 0.5 mm Pitch WDFN Packages
- These Devices are Pb-Free and are RoHS Compliant

Applications

- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs etc.
- EMI Filtering for Data Ports in Cell Phones, PDAs or Notebook Computers
- EMI Filtering for LCD, Camera and Chip-to-Chip Data Lines

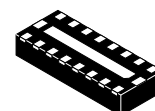


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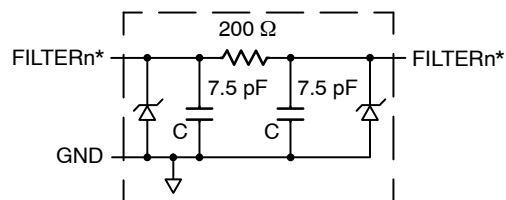


WDFN8
DF/DE SUFFIX
CASE 511BE



WDFN16
DF/DE SUFFIX
CASE 511AU

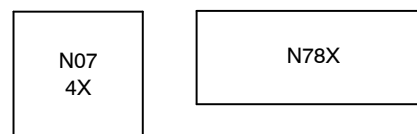
BLOCK DIAGRAM



1 of 4/8 EMI Filtering + ESD Channels

*See Package/Pinout Diagrams for Expanded Pin Information.

MARKING DIAGRAM



N07 4X = Specific Device Code
N78X = Specific Device Code

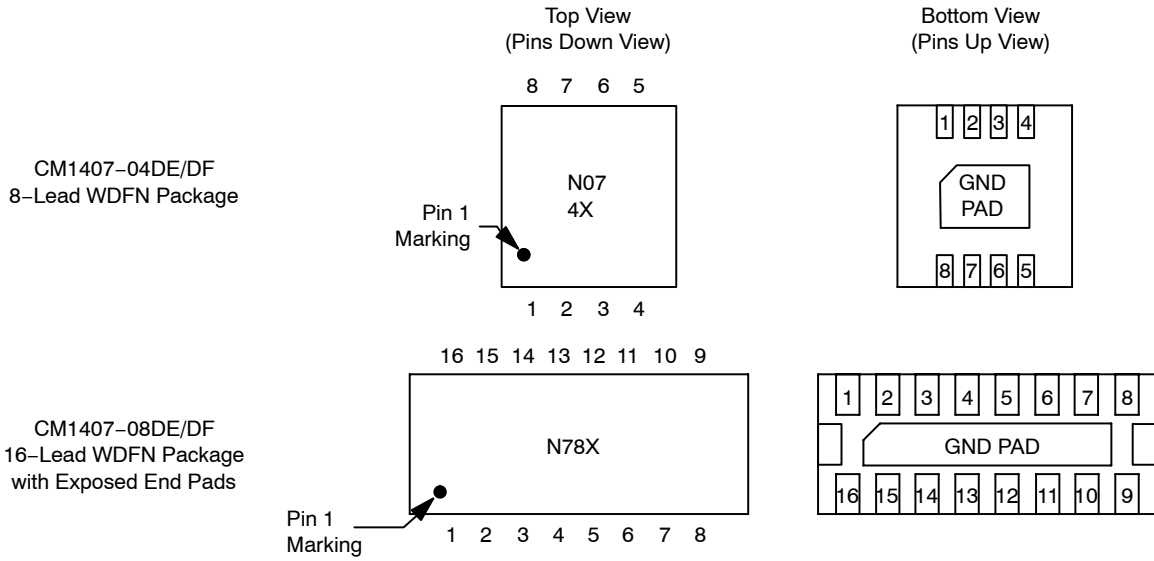
ORDERING INFORMATION

| Device | Package | Shipping† |
|-------------|---------------------|------------------|
| CM1407-04DF | WDFN8 (Pb-Free) | 3000/Tape & Reel |
| CM1407-08DF | WDFN16 (Pb-Free) | 3000/Tape & Reel |
| CM1407-04DE | WDFN8 (Pb-Free) | 3000/Tape & Reel |
| CM1407-08DE | WDFN16 (Pb-Free) | 3000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

CM1407

PACKAGE / PINOUT DIAGRAMS



Note: See Ordering Information section for device specific marking.

Table 1. PIN DESCRIPTIONS

| Pins | | Name | Description | Pins | | Name | Description |
|-----------|-----------|---------|------------------|-----------|-----------|---------|------------------|
| 1406-04Dx | 1406-08Dx | | | 1406-04Dx | 1406-08Dx | | |
| 1 | 1 | FILTER1 | Filter Channel 1 | 8 | 16 | FILTER1 | Filter Channel 1 |
| 2 | 2 | FILTER2 | Filter Channel 2 | 7 | 15 | FILTER2 | Filter Channel 2 |
| 3 | 3 | FILTER3 | Filter Channel 3 | 6 | 14 | FILTER3 | Filter Channel 3 |
| 4 | 4 | FILTER4 | Filter Channel 4 | 5 | 13 | FILTER4 | Filter Channel 4 |
| | 5 | FILTER5 | Filter Channel 5 | | 12 | FILTER5 | Filter Channel 5 |
| | 6 | FILTER6 | Filter Channel 6 | | 11 | FILTER6 | Filter Channel 6 |
| | 7 | FILTER7 | Filter Channel 7 | | 10 | FILTER7 | Filter Channel 7 |
| | 8 | FILTER8 | Filter Channel 8 | | 9 | FILTER8 | Filter Channel 8 |
| GND Pad | | GND | Device Ground | | | | |

CM1407

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

| Parameter | Rating | Units |
|---------------------------|-------------|-------|
| Storage Temperature Range | -65 to +150 | °C |
| DC Power per Resistor | 100 | mW |
| Package DC Power Rating | 300 | mW |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

| Parameter | Rating | Units |
|-----------------------------|------------|-------|
| Operating Temperature Range | -40 to +85 | °C |

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|--------------------|------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------|-------------|-------------|-------------|-------|
| R | Resistance | | 160 | 200 | 240 | Ω |
| C | Capacitance | At 2.5 V DC, 1 MHz, 30 mV AC | 6 | 7.5 | 9 | pF |
| V _{DIODE} | Diode Standoff Voltage | I _{DIODE} = 10 μA | | 6.0 | | V |
| I _{LEAK} | Diode Leakage Current (Reverse Bias) | V _{DIODE} = 3.3 V | | 0.1 | 1 | μA |
| V _{SIG} | Signal Voltage Positive Clamp Negative Clamp | I _{LOAD} = 10 mA I _{LOAD} = -10 mA | 5.6 -1.5 | 6.8 -0.8 | 9.0 -0.4 | V |
| V _{ESD} | In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4 | (Note 2) | 30 15 | | | kV |

1. T_A = 25°C unless otherwise specified.
2. ESD applied to input and output pins with respect to GND, one at a time.

CM1407

PERFORMANCE INFORMATION

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

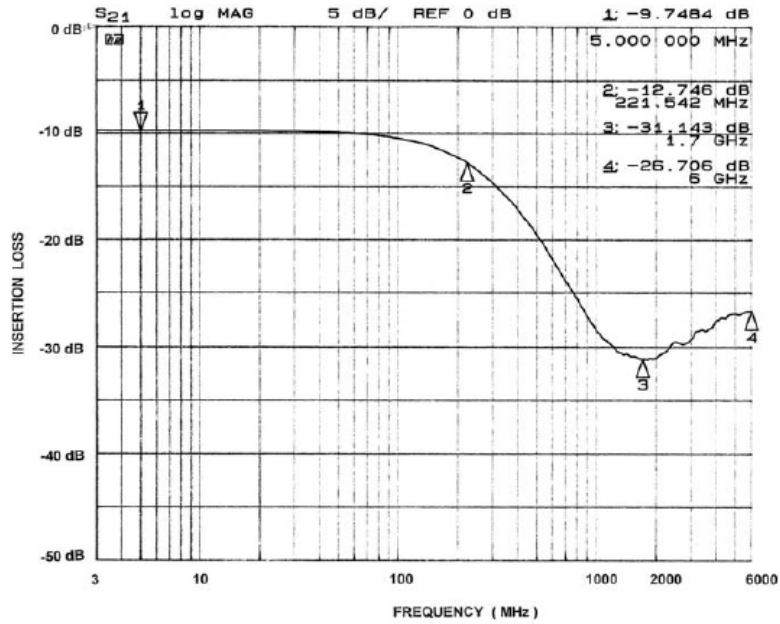


Figure 1. Channel 1 EMI Filter Performance (CM1407-04)

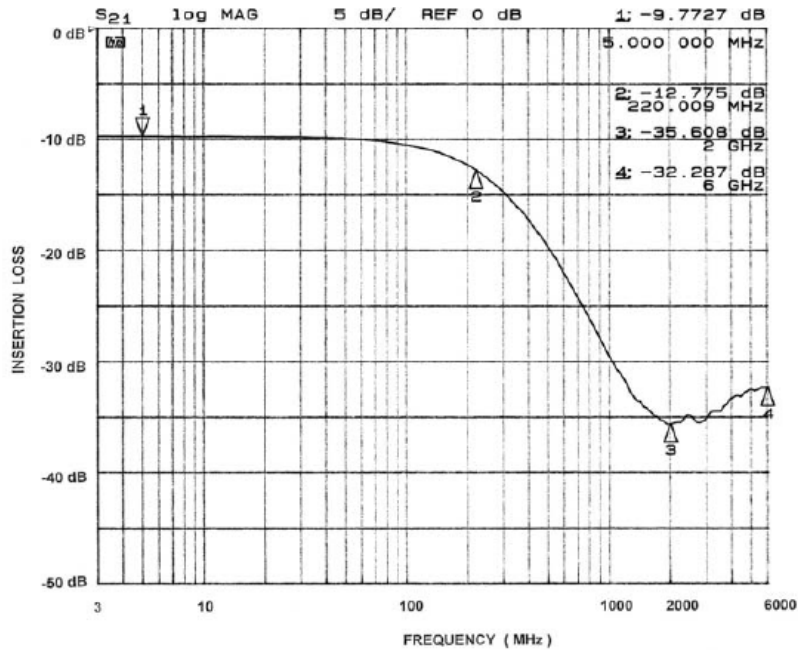


Figure 2. Channel 2 EMI Filter Performance (CM1407-04)

CM1407

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

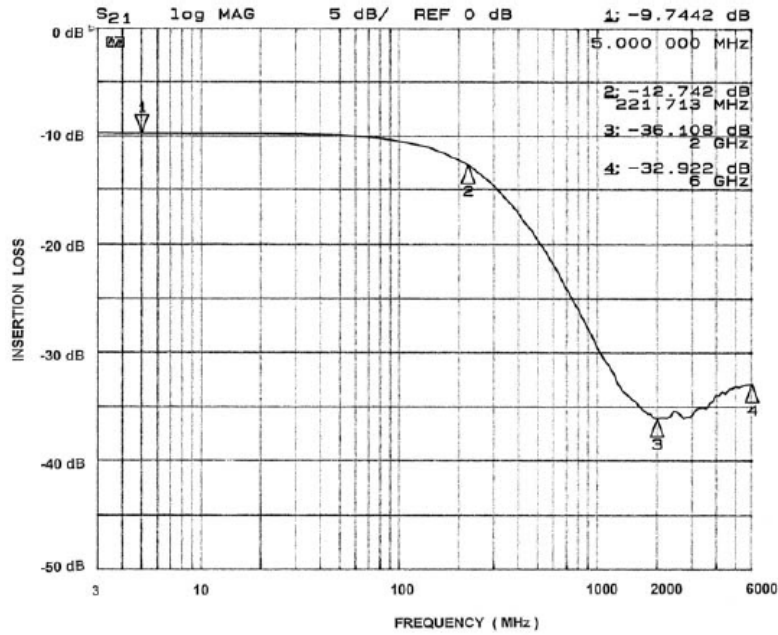


Figure 3. Channel 3 EMI Filter Performance (CM1407-04)

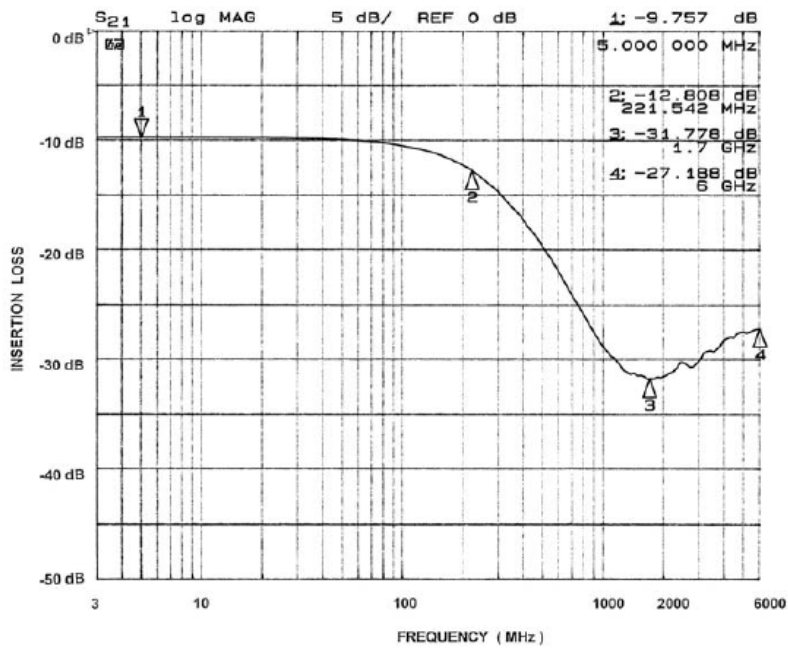


Figure 4. Channel 4 EMI Filter Performance (CM1407-04)

CM1407

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

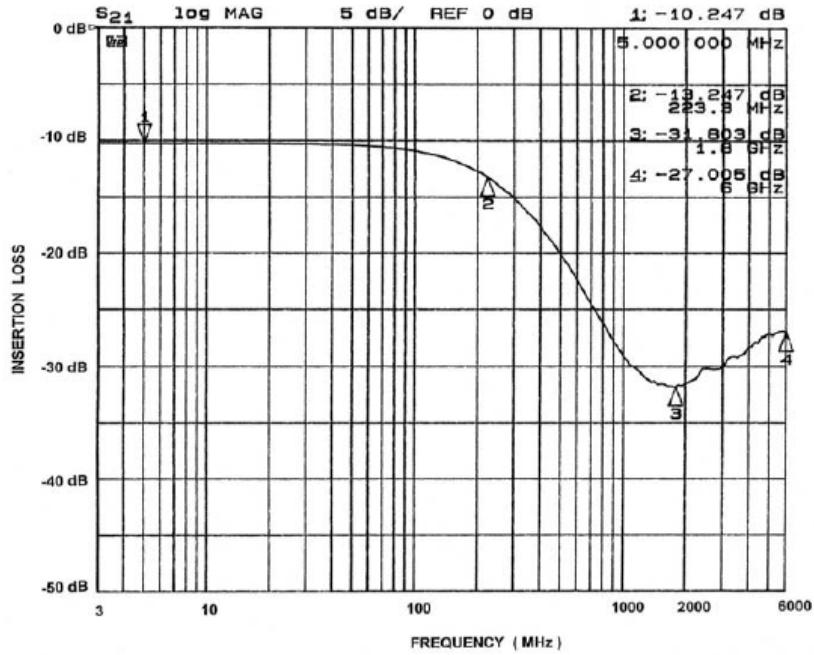


Figure 5. Channel 1 EMI Filter Performance (CM1407-08)

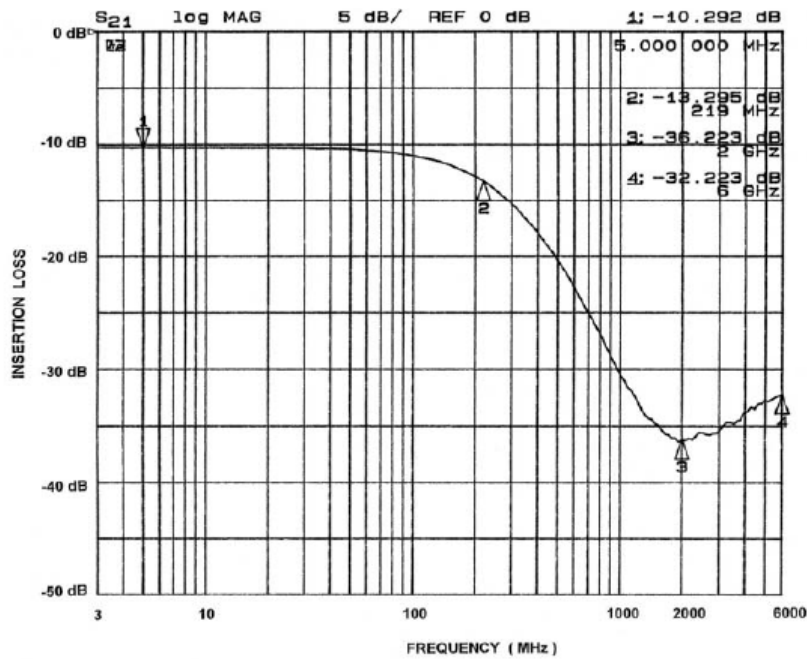


Figure 6. Channel 2 EMI Filter Performance (CM1407-08)

CM1407

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

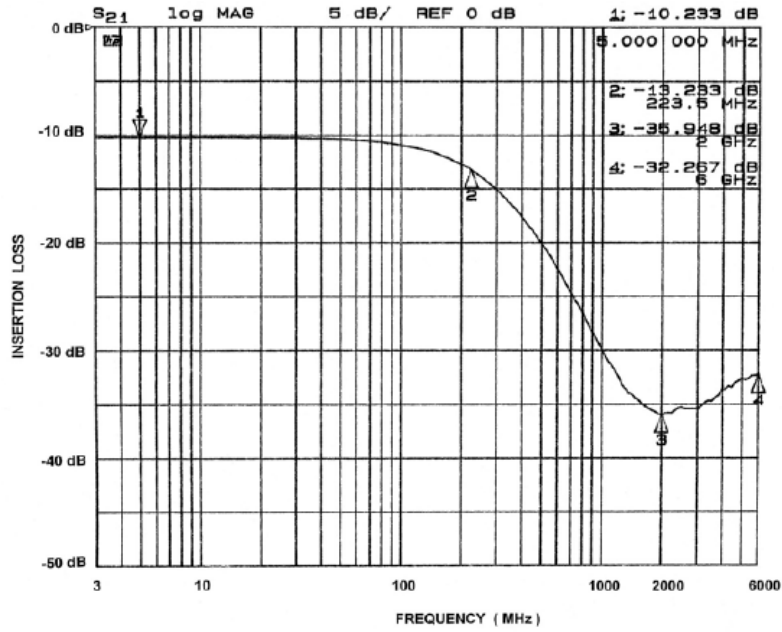


Figure 7. Channel 3 EMI Filter Performance (CM1407-08)

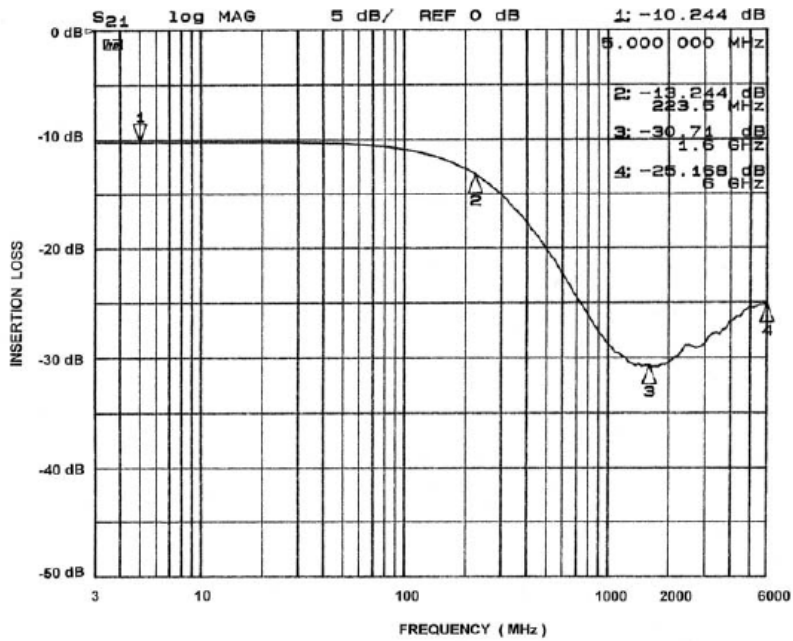


Figure 8. Channel 4 EMI Filter Performance (CM1407-08)

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PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

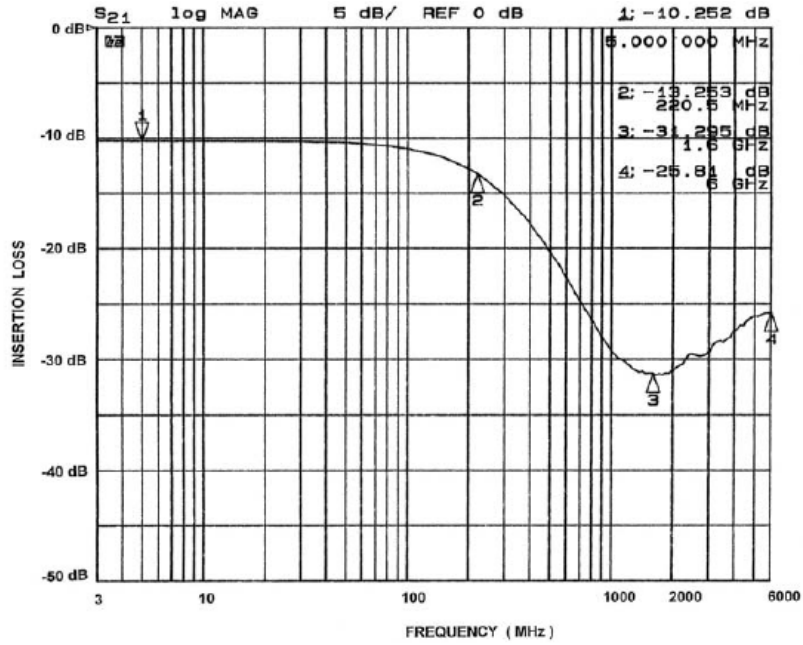


Figure 9. Channel 5 EMI Filter Performance (CM1407-08)

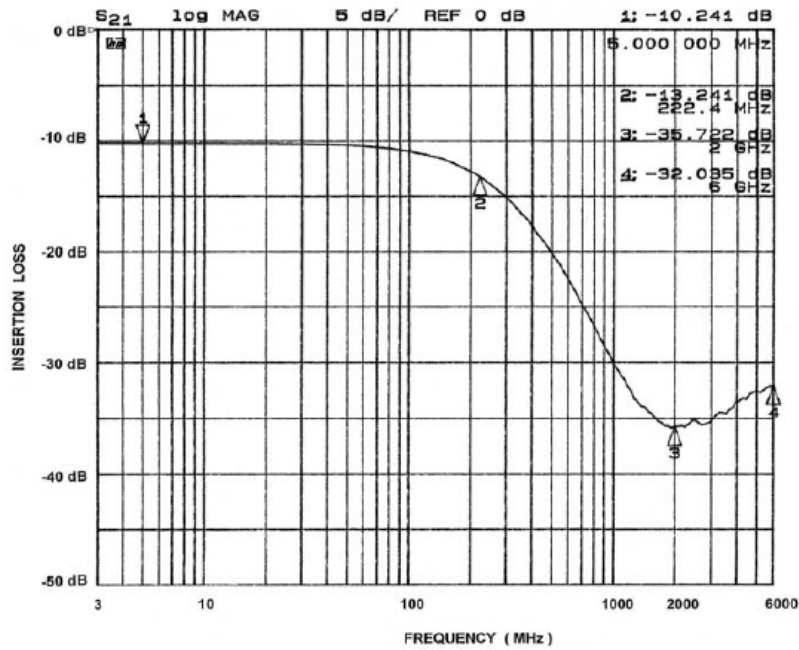


Figure 10. Channel 6 EMI Filter Performance (CM1407-08)

CM1407

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

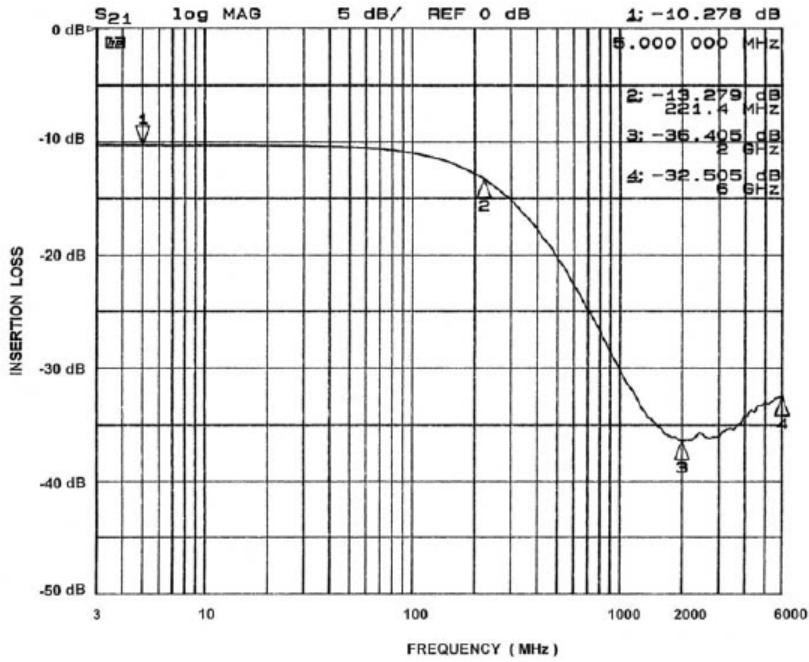


Figure 11. Channel 7 EMI Filter Performance (CM1407-08)

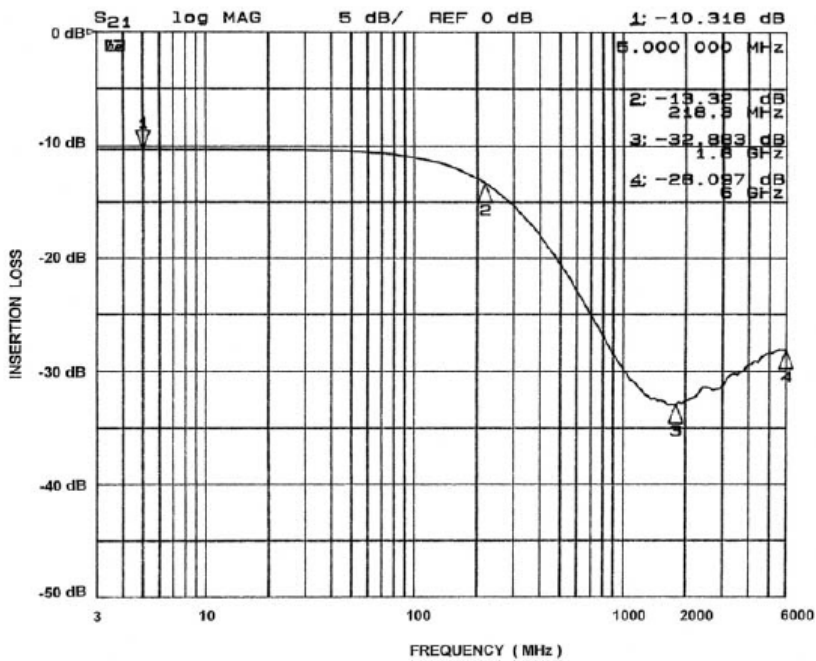


Figure 12. Channel 8 EMI Filter Performance (CM1407-08)

PERFORMANCE INFORMATION (Cont'd)

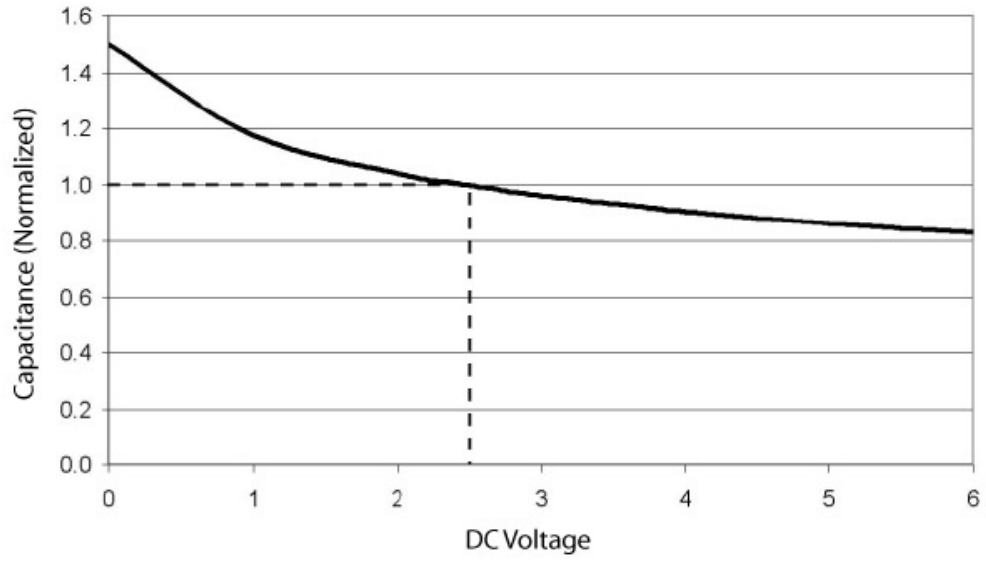
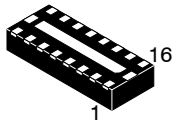


Figure 13. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5 V DC and 25°C)

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

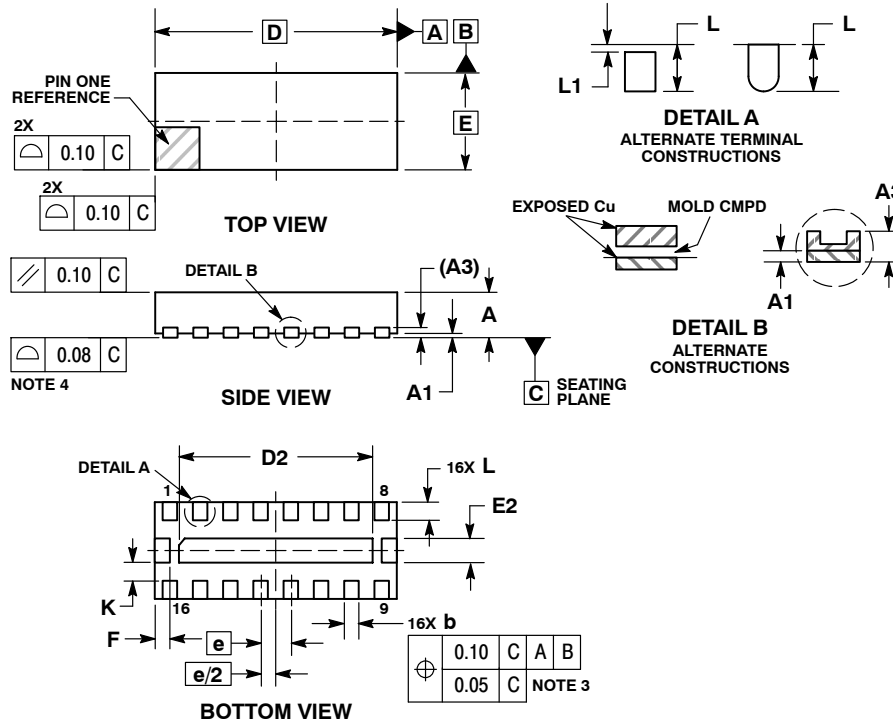
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SCALE 4:1

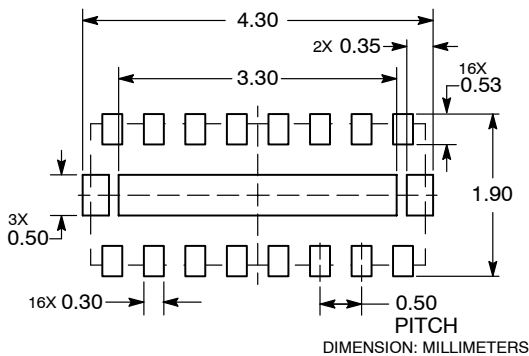
WDFN16, 4x1.6, 0.5P
CASE 511AU-01
ISSUE O

DATE 06 JUL 2010



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

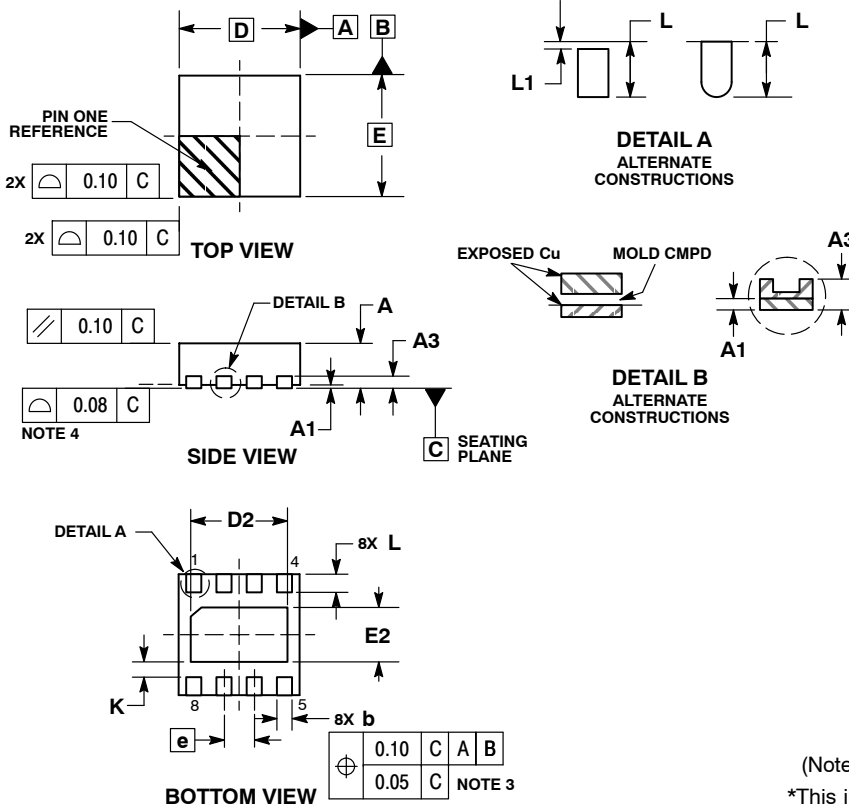
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SCALE 2:1

WDFN8 2x2, 0.5P
CASE 511BE-01
ISSUE A

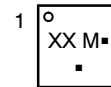
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 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS | |
|-----|-------------|------|
| | MIN | MAX |
| A | 0.70 | 0.80 |
| A1 | 0.00 | 0.05 |
| A3 | 0.20 | REF |
| b | 0.20 | 0.30 |
| D | 2.00 | BSC |
| D2 | 1.50 | 1.70 |
| E | 2.00 | BSC |
| E2 | 0.80 | 1.00 |
| e | 0.50 | BSC |
| K | 0.25 | REF |
| L | 0.20 | 0.40 |
| L1 | --- | 0.15 |

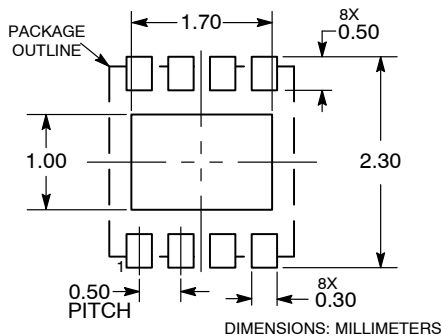
GENERIC MARKING DIAGRAM*



- XX = Specific Device Code
- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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| DESCRIPTION: | WDFN8, 2X2, 0.5P | PAGE 1 OF 1 |

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